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To: Material Declaration Team
Attn: Whom it may concern

Date: July 16, 2024

ROHS AND REACH COMPLIANCE DECLARATION

Re: TGS all products

We confirm that every standard part delivered to customer is in conformity with EUROPEAN RoHS Directive 2011/65/EU & (EU) 2015/863 in the current version, including the latest ten hazardous substances controlled by RoHS2.0(lead, cadmium, mercury, hexavalent chromium, PBB, PBDE, BBP, DBP, DEHP and DIBP) limited value requirements' and it is in conformity with European REACH Regulation (EC) No. 1907/2006 in the current version, including a total of 240 SVHCs on the candidate substances list.

Remark:

The Pb contained in the solder & GPP chips in all our products are RoHS exempted items(2011/534/EU). The exemptions are as follows:

- Lead in solder is a RoHS exempt item. The exemption clause is 7(a). Lead in high melting temperature type solder (ie Lead-based alloy solder with lead content exceeding 85%);
- The high-lead glass contained in the GPP chip, the lead in which belongs to RoHS exemption. The exemption is: 7(c)-I. Leads contained in glass or ceramic materials in electronics and electrical components (except glass or ceramic dielectrics in capacitors) in electronic and electrical components, such as piezoelectric ceramic devices or glass /ceramic based mixtures (composite components).

When RoHS has a new directive to redefine or abolish the above exemption, we will make a separate declaration, otherwise this declaration will remain valid.

The declaration takes effect immediately at the time of signature and stamping.

Jack Zhang



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